

INTERNATIONAL ELECTROTECHNICAL COMMISSION

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**IEC 61191-2**  
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**PRINTED BOARD ASSEMBLIES –**  
**Part 2: Sectional specification –**  
**Requirements for surface mount soldered assemblies**

**C O R R I G E N D U M 1**

**Figure 5 – J lead joint**

*Replace, in the table, footnote f by footnote d, and delete footnote e.*